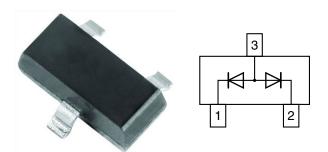


Vishay Semiconductors

Dual Common Anode Small Signal High Voltage Switching Diode



LINKS TO ADDITIONAL RESOURCES



MECHANICAL DATA

Case: SOT-23 Weight: approx. 9.2 mg Packaging codes / options: 18/10K per 13" reel (8 mm tape), 10K/box 08/3K per 7" reel (8 mm tape), 15K/box

FEATURES

- Silicon epitaxial planar diode
- · Fast switching dual common anode diode, especially suited for applications requiring high voltage capability
- AEC-Q101 qualified available (part number on request)
- Molding compound meets UL 94 V-0 flammability rating
- Moisture sensitivity level (MSL) 1
- Base P/N-G3 green, commercial grade
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

PARTS TABLE							
PART	ORDERING CODE	AEC-Q101 QUALIFIED	TYPE MARKING	CIRCUIT CONFIGURATION	TAPED UNITS PER REEL	MINIMUM ORDER QUANTITY	
GSD2004A-G	GSD2004A-G3-08	no	DBH	Common anode	3 000 (8 mm tape on 7" reel)	15 000	
	GSD2004A-G3-18	no			10 000 (8 mm tape on 13" reel)	10 000	

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Continuous reverse voltage		V _R	240	V	
Peak repetitive reverse voltage		V _{RRM}	300	V	
Forward current (continuous) ⁽¹⁾		IF	350	mA	
Peak repetitive forward current ⁽¹⁾		I _{FRM}	625	mA	
Non-repetitive peak forward current (1)	t _p = 1 μs	1	4	А	
Non-repetitive peak forward current ()	t _p = 1 s	I _{FSM}	1	А	
Power dissipation	on FR-4 board with recommended soldering footprint	D	300	mW	
rower dissipation	Infinite heatsink	P _{tot}	500	mW	

Note

(1) Infinite heatsink

THERMAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
Typical thermal resistance junction to ambient air	according to JEDEC [®] 51-3 on FR-4 board with recommended soldering footprint	R _{thJA}	420	K/W		
Thermal resistance junction to lead	Infinite heatsink	R _{thJL}	250	K/W		
Junction temperature		Tj	150	°C		
Storage temperature range		T _{stg}	-65 to +150	°C		
Operating temperature range		T _{op}	-55 to +150	°C		

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<u>GREEN</u> (5-2008)

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ISHA

GSD2004A-G

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ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Reverse breakdown voltage	I _R = 100 μA	V _{BR}	300			V
Laskaga aurrant	V _R = 240 V	I _R			100	nA
Leakage current	$V_{R} = 240 \text{ V}, \text{ T}_{j} = 150 ^{\circ}\text{C}$	I _R			100	μA
Forward valtage	I _F = 20 mA	V _F		0.83	0.87	V
Forward voltage	I _F = 100 mA	VF			1	V
Diode capacitance	$V_F = V_R = 0$, f = 1 MHz	CD			2	pF
Reverse recovery time	$I_{F} = I_{R} = 30 \text{ mA}, i_{R} = 3 \text{ mA}, \\ R_{L} = 100 \Omega$	t _{rr}			50	ns

TYPICAL CHARACTERISICS (T_{amb} = 25 °C, unless otherwise specified)

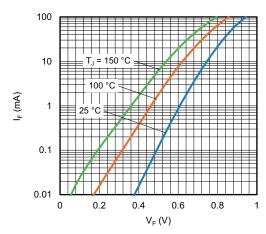


Fig. 1 - Forward Current vs. Forward Voltage

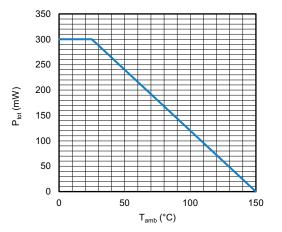


Fig. 2 - Admissible Power Dissipation vs. Ambient Temperature

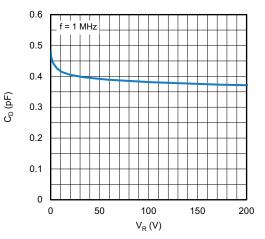


Fig. 3 - Typical Capacitance vs. Reverse Voltage

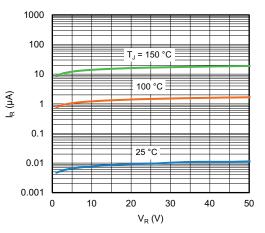


Fig. 4 - Typical Reverse Leakage Current vs. Reverse Voltage

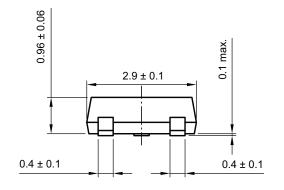
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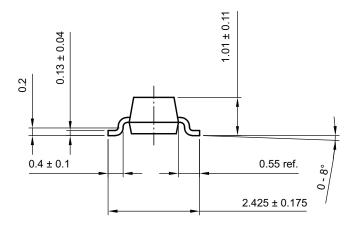
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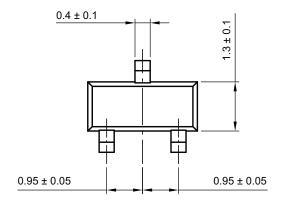
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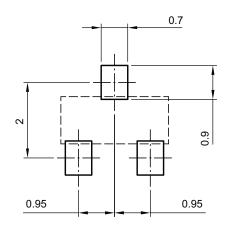
PACKAGE DIMENSIONS in millimeters: SOT-23







footprint recommendation:

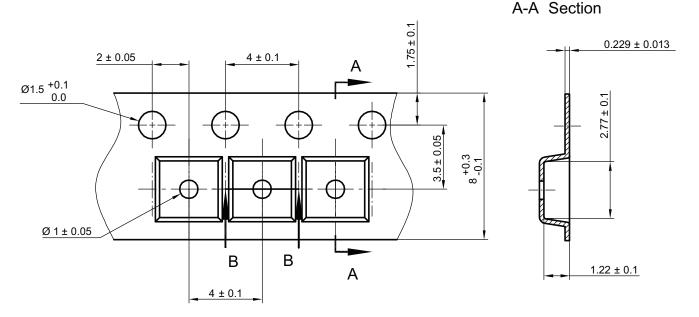


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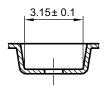
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CARRIER TAPE SOT-23

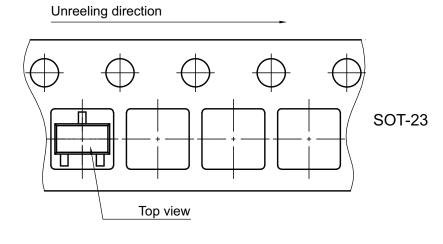


B-B Section



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ORIENTATION IN CARRIER TAPE SOT-23



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